

11/23/3

Form 1449 (Modified) Information Disclosure Statement By Applicant (Use Several Sheets if Necessary)	Atty Docket No.	Application No.:
	ALTRP096/A1201	To be assigned
	Applicant:	10/719451
	Wen-chou Vincent Wang et al.	
Filing Date	Group	2815
Herewith 11/20/03	Unknown	

U.S. Patent Documents

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
	A						
	B						
	C						
	D						
	E						
	F						
	G						
	H						
	I						

Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation	
							Yes	No
	J							
	K							
	L							
	M							
	N							

Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
gbe	O	U.S. Patent Application Serial No. 10/305,671 filed on November 25, 2002 entitled "Flip Chip Package With Warpage Control"
	P	
	Q	
Examiner	Jasmine Clark	
	Date Considered 12/09/04	

Examiner: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.